### Innovating Energy Technology

# **FMP60N079S2HF**

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**FUJI POWER MOSFET** 

## Super J MOS® S2 series

### N-Channel enhancement mode power MOSFET

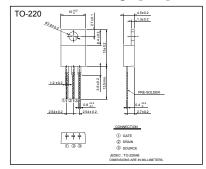
#### Features

Pb-free lead terminal RoHS compliant uses Halogen-free molding compound

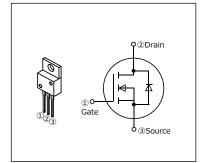
### Applications

For switching

### Outline Drawings [mm]



### Equivalent circuit schematic



### ■ Absolute Maximum Ratings at T<sub>c</sub>=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Course Voltage	<b>V</b> <sub>DS</sub>	600	V	
Drain-Source Voltage	<b>V</b> <sub>DSX</sub>	600	V	V <sub>GS</sub> =-30V
Continuous Drain Current	I <sub>D</sub>	47.9	Α	<i>T</i> <sub>c</sub> =25°C Note*1,2
Continuous Drain Current		30.3	Α	T <sub>c</sub> =100°C Note*1,2
Pulsed Drain Current	<b>I</b> DP	148	Α	Note *2
Gate-Source Voltage	<b>V</b> <sub>GS</sub>	±30	V	
Non-Repetitive Maximum Avalanche Current	<b>I</b> AS	5.5	А	Note *3
Non-Repetitive Maximum Avalanche Energy	<b>E</b> as	1177	mJ	Note *4
Maximum Drain-Source dV/dt	d <i>V</i> ⊳s/dt	50	V/ns	V <sub>DS</sub> ≤ 600V
Continuous	,	47.9	Α	<i>T</i> <sub>c</sub> =25°C Note*1,2
Diode Forward Current	<b>/</b> sd	30.3	Α	T <sub>c</sub> =100°C Note*1,2
Pulsed Diode Forward Current	<b>I</b> SDP	148	Α	Note 2
Peak Diode Recovery dV/dt	dV/dt	15	V/ns	Note *5
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *6
Maximum Dawar Discination	<b>P</b> D	2.02	W	<i>T</i> <sub>a</sub> =25°C
Maximum Power Dissipation	FD	270	VV	<i>T</i> <sub>c</sub> =25°C
Oneveting and Stayone Temperature range	T <sub>ch</sub>	150	°C	
Operating and Storage Temperature range	$\mathcal{T}_{stg}$	-55 to +150	°C	

Note \*1 : Maximum duty cycle D=0.6

Note \*1: Imited by maximum cuty cycle D=0.0
Note \*3: Imited by maximum channel temperature.
Note \*3: T<sub>ch</sub>≤150°C, See Fig.1 and Fig.2
Note \*4: Starting T<sub>ch</sub>=25°C, I<sub>A</sub>s=3.3A, L=198mH, V<sub>DD</sub>=60V, R<sub>G</sub>=50Ω, See Fig.1 and Fig.2
E<sub>AS</sub> limited by maximum channel temperature and avalanche current.
Note \*5: I<sub>SD</sub>≤37.1A, -di/dt≤100A/µs, V<sub>DS</sub> peak≤600V, T<sub>ch</sub>≤150°C.
Note \*6: I<sub>SD</sub>≤37.1A, dV/dt≤15V/ns, V<sub>DS</sub> peak≤600V, T<sub>ch</sub>≤150°C.

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# ■ Electrical Characteristics at *T*<sub>c</sub>=25°C (unless otherwise specified) • Static Ratings

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA		600	-	-	٧
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> I <sub>D</sub> =1.95mA		3.5	4.0	4.5	V
Zero Gate Voltage Drain Current	<b>I</b> bss	V <sub>DS</sub> =600V V <sub>GS</sub> =0V	T <sub>ch</sub> =25°C	-	-	25	μА
		V <sub>DS</sub> =480V V <sub>GS</sub> =0V	<i>T</i> <sub>ch</sub> =125°C	-	-	250	
Gate-Source Leakage Current	IGSS	V <sub>DS</sub> =0V V <sub>GS</sub> = ± 30V	·	-	10	100	nA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V I <sub>D</sub> =18.6A		-	0.071	0.079	Ω
Gate resistance	<b>R</b> <sub>G</sub>	f=1MHz, open drain		-	7.2	_	Ω

### Dynamic Ratings

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =25V I <sub>D</sub> =18.6A	12.2	24.5	-	S
Input Capacitance	Ciss	V <sub>DS</sub> =400V	-	2030	-	
Output Capacitance	Coss	V <sub>GS</sub> =0V	-	67	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	8.7	-	
Effective output capacitance, energy related (Note *7)	C <sub>o(er)</sub>	V <sub>DS</sub> =0400V V <sub>GS</sub> =0V	-	158	-	pF
Effective output capacitance, time related (Note *8)	C <sub>o(tr)</sub>	V <sub>DS</sub> =0400V V <sub>GS</sub> =0V I <sub>D</sub> =constant	-	633	-	
Turn-On Time	t <sub>d(on)</sub>	$V_{\text{DD}}$ =400V, $V_{\text{GS}}$ =10V $I_{\text{D}}$ =18.6A, $R_{\text{G}}$ =12Ω See Fig.3 and Fig.4	-	28	-	
Turn-On Time	<b>t</b> r		-	98	-	
Turn-Off Time	t <sub>d(off)</sub>		-	140	-	ns
Turn-Off Time	<b>t</b> f		-	26	-	
Total Gate Charge	<b>Q</b> <sub>G</sub>		-	80	-	
Gate-Source Charge	<b>Q</b> GS	V <sub>DD</sub> =400V, V <sub>GS</sub> =10V I <sub>D</sub> =37.1A See Fig.5	-	29	-	<b>~</b> C
Gate-Drain Charge	<b>Q</b> <sub>GD</sub>		-	34	-	nC
Drain-Source crossover Charge	<b>Q</b> sw		-	18	-	

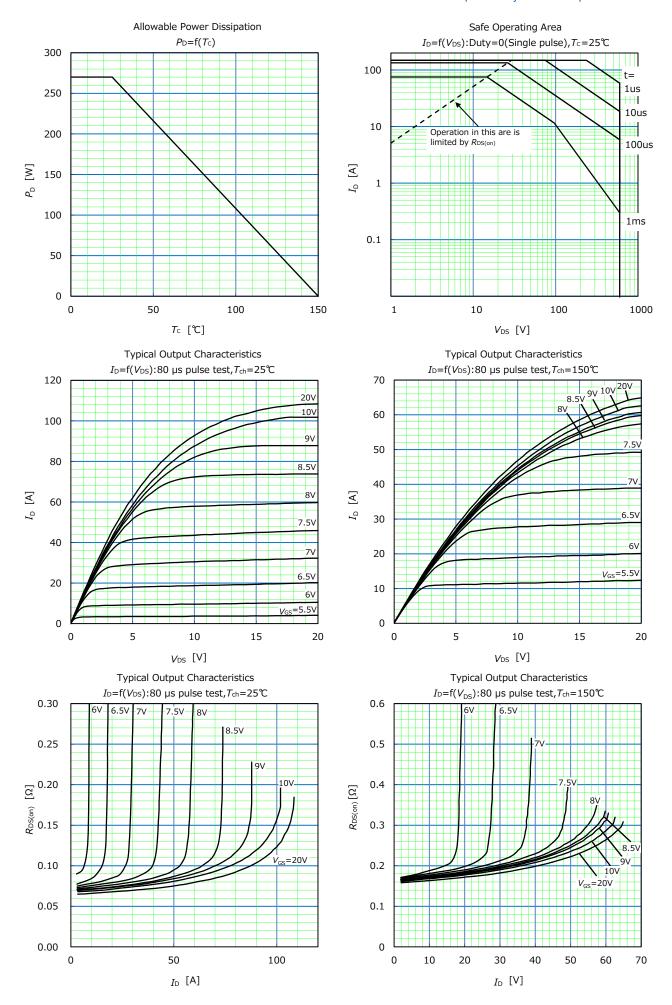
Note  $^*7$ :  $C_{0(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{Ds}$  is rising from 0 to 400V. Note  $^*8$ :  $C_{o(er)}$  is a fixed capacitance that gives the same charging times as  $C_{oss}$  while  $V_{Ds}$  is rising from 0 to 400V.

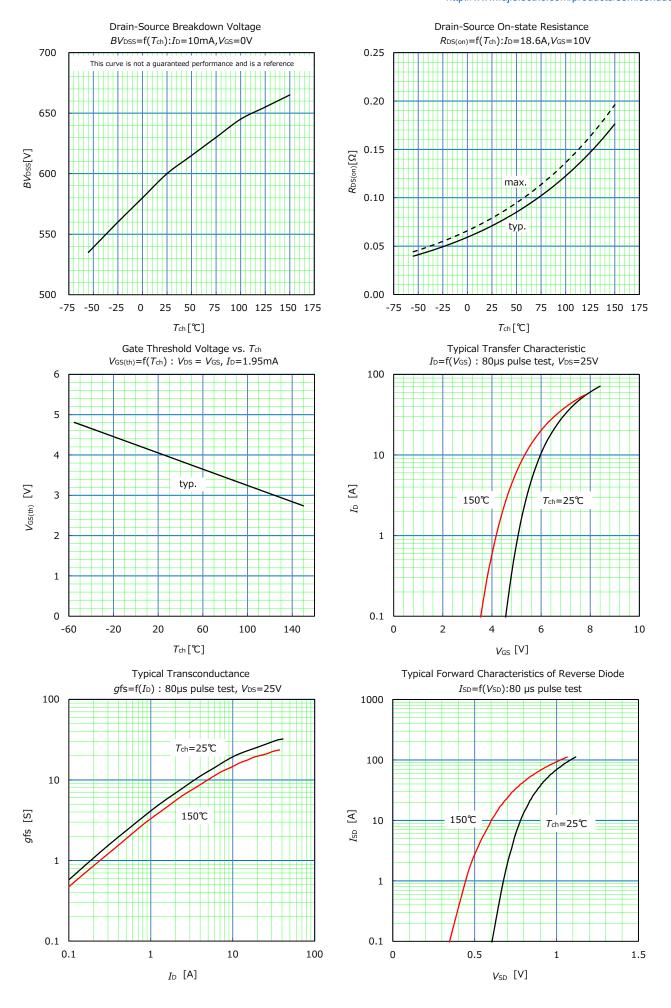
### • Reverse Diode

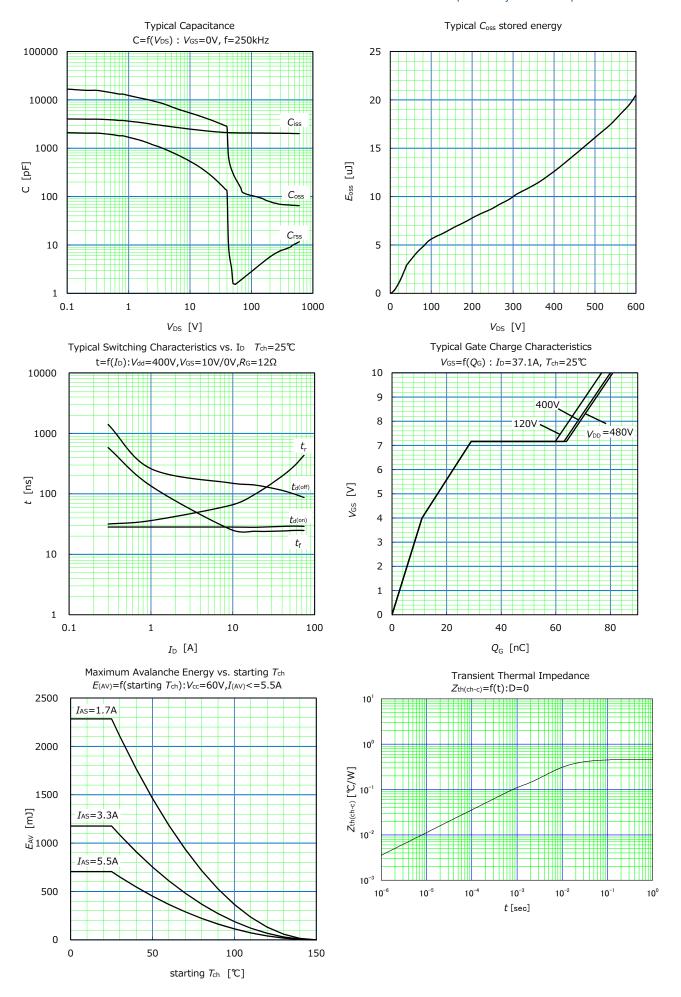
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	<b>V</b> <sub>SD</sub>	I <sub>SD</sub> =37.1A, V <sub>GS</sub> =0V T <sub>ch</sub> =25°C	-	0.90	1.35	V
Reverse Recovery Time	<b>t</b> rr	- V <sub>DD</sub> =400V, I <sub>SD</sub> =37.1A -di/dt=100A/μs Τ <sub>ch</sub> =25°C See Fig.6 and Fig.7	-	380	-	ns
Reverse Recovery Charge	Qrr		-	6.6	-	μC
Peak Reverse Recovery Current	<b>I</b> rp		-	34	-	Α

### ■ Thermal Resistance

Parameter	Symbol	Min.	Тур.	Max.	Unit
Channel to Case	R <sub>th(ch-c)</sub>	-	-	0.463	°C/W
Channel to Ambient	R <sub>th(ch-a)</sub>	-	-	62	°C/W







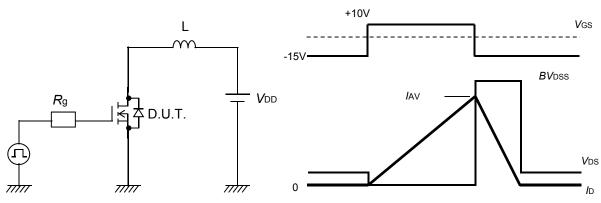


Fig.1 Avalanche Test circuit

Fig.2 Operating waveforms of Avalanche Test

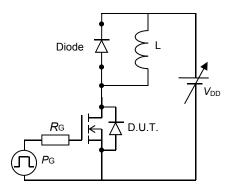


Fig.3 Switching Test circuit

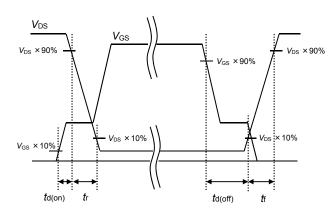


Fig.4 Operating waveform of Switching Test

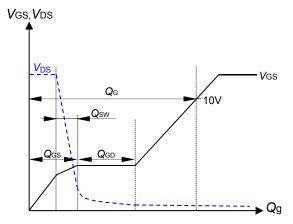


Fig.5 Operating waveform of Gate charge Test

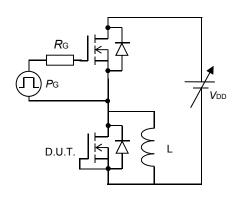


Fig.6 Reverse recovery Test circuit

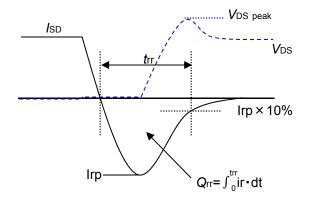
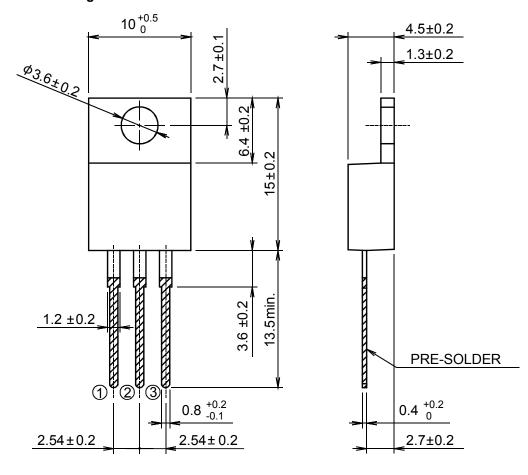
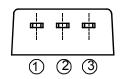


Fig.7 Operating waveform of Reverse recovery Test

### Outview: TO-220 Package





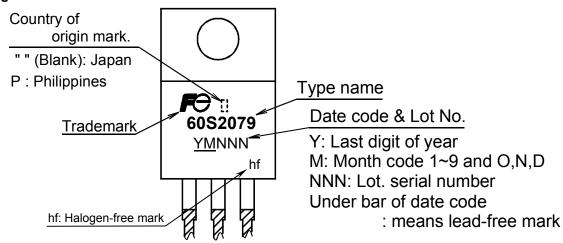
### CONNECTION

- ① GATE
- 2 DRAIN
- 3 SOURCE

JEDEC: TO-220AB

DIMENSIONS ARE IN MILLIMETERS.

### Marking



<sup>\*</sup> The font (font type,size) and the trademark-size might be actually different.

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